LIST OF THE CLAIMS

- (Original) A bipolar band-to-band infrared photodetector-diode, or laser diode, or light-emitting diode, or amplifier, or electrooptic modulator-diode comprising
 - (a) a silicon substrate,
 - (b) a strain-relaxed Ge_{1-y}Sn_y or Ge_{1-y-z}Sn_ySi_z buffer layer upon Si, known as a virtual substrate, VS
 - (c) an active direct-bandgap region made up of a single-quantum-well heterostructure or a multi-quantum-well stack,
 - (d) a strain-relieved capping layer of Ge_{1-y}Sn_y or Ge_{1-y-z}Sn_ySi_z matching the VS composition,
 - (e) metallic electrical contacts to the Si substrate and/or capping layer.
- 2. (Original) The devices of claim 1 wherein the substrate is doped N-type or P-type while the capping layer is doped P-type or N-type to form an NIP or PIN diode,
- (Original) The devices of claims 1,2 wherein the VS is Ge_{1-y}Sn_y and the active region is a strain balanced type-I stack of compressive Ge_{1-2y}Sn_{2y} quantum wells with tensile Ge barriers.
- 4. (Original) The devices of claims 1,2,3 wherein the composition y ranges from0.02 to 0.15 for device operation at wavelengths ranging from 1.55 to 5.00 μm.
- 5. (Original) The photodetector devices of claims 1,3,4 in which the substrate is doped N or P type and the cap layer contact is an Schotty barrier metal.

- 6. (Original)The photodetector devices of claims 1,3,4 in which the substrate is undoped and an interleaved pair of metal electrodes is employed upon the cap layer.
- 7. (Original) The devices of claims 1,2 wherein the VS is Ge_{1-y}Sn_y and the active region is an unsymmetrically strained type-II heterostructure with holes confined in a tensile Ge layer and electrons confined in the relaxed buffer layer.
- 8. (Original) The devices of claims 1,2 wherein the VS is Ge_{1-y-z}Sn_ySi_z and the active region is an unsymmetrically strained type-I heterostructure with electrons-and-holes confined in a tensile Ge layer.
- 9. (Original) The devices of claim 8 wherein y and z are approximately 0.2.
- 10. (Original) A unipolar intersubband long-wave-infrared photodetector-diode, or laser diode, or light emitting diode, or amplifier, or electrooptic modulator diode comprising:
 - (a) a silicon substrate
 - (b) a strain-relaxed Ge_{1-y}Sn_y buffer layer upon Si, known as a virtual substrate, VS
 - (c) an active direct-bandgap region made up of a strain-balanced type-I multiquantum-well stack which has compressive $Ge_{1-2y}Sn_{2y}$ wells and tensile Ge barriers,
 - (d) a strain-relieved capping layer of Ge_{1-y}Sn_y that matches the VS composition,
 - (e) metallic electrical contacts to the Si substrate and/or capping layer.

- 11. (Original) The photodetector devices of claim 10 wherein the VS and cap and quantum wells are doped N type
- 12. (Original) The photodector devices of claim 10 wherein the VS and cap and quantum wells are doped P type
 - 13. (Original) The laser, emitter, amplifier and modulator devices of claim 10 wherein the VS and cap are both doped N-type or both doped P-type for electron injection or for hole injection, respectively.
 - 14. (Original) The laser, emitter, amplifier and modulator devices of claim 10 wherein the resonant tunneling of injected carriers is used between adjacent periods of the active region in the manner of a quantum cascade.